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Optical band gap modulation by Mg-doping in In₂O₃(ZnO)₃ ceramics

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Abstract

In this study, different amounts of Mg were doped in $In_2O_3(Zn_{1-x}Mg_xO)_3$ and their thin films were grown by using the RF magnetron sputtering method. The optical and electrical characteristics of the films revealed that the lattice constant decreased while the optical band gap increased as the Mg content increased, showing an inverse proportional relationship with each other. Therefore, it was found that Mg doping in indium zinc oxide (IZO) is also effective for band gap modulation as it was reported in a Mg-doped ZnO system. When IZO thin films were grown in a more reducing ambient, the carrier concentration increased which resulted in the increase of band gap energy. This was explained due to the Burstein–Moss effect.

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1. Introduction

Wide band gap semiconductors such as Sn-doped In₂O₃ (ITO), Sb-doped SnO₂ (ATO) and Al-doped ZnO (AZO) have attracted attention because of their great potential for applications regarding transparent conducting electrodes in a variety of optoelectronic devices such as displays, solar cells, electrochromic devices and light emitting diodes [1–3]. Particularly, the band gap engineering of wide band gap semiconducting materials has become an essential technology to make the various kinds of optoelectronic devices work properly with high efficiency and functionality.

One good example of band gap modulation could be found in light emitting diode (LED) materials. In the case of the heteroepitaxial layers between the III–V group compounds of InAs and GaAs, the lattice constant of the materials was found to have a close correlation with their band gap energy, i.e., band gaps are inversely proportional to the lattice constant. So, the decrease in In/Ga ratios (as the value of x decreases in $In_xGa_{1-x}As$) permits the band gap to be increased from 0.36 eV to

1.43 eV whereas their lattice constant decreases from 6.06 Å to 5.64 Å [4].

In the exploitation and tailoring of wide band gap semiconductors, doping could be one of the most promising methods, and it can lead to increased carrier concentration, improved electrical characteristics, and modified band gap energy. In the context of band gap modulation of ZnO, research has shown that the band gap of ZnO can be adjusted with a doping of Mg, Al or Cd [5–8]. When Mg is doped in ZnO, however, its lattice constant is only slightly different (around 1%) from that of ZnO [9].

On the other hand, it has been reported that the band gap depends on carrier concentration. In the compound of the ZnO-In₂O₃ system, Naghavi et al. [10] and Moriga et al. [11] reported that the carrier concentration decreased together with band gap energy as the Zn content increased ([Zn]/([In]+[Zn])). This type of band gap modulation was explained by the Burstein-Moss effect [12,13] and showed that the filling of states in the conduction band causes an increase of the direct optical band gap in the degenerated semiconductors with curved bands.

Recently, the In₂O₃–ZnO (IZO) system has emerged as one of the most promising transparent conducting oxides due to its high transparency and electrical conductivity.

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Among the various homologous compounds of In₂O₃ $(ZnO)_k$ (k=3-9, 11, 13, 15), $In_2O_3(ZnO)_{k=3}$ (IZO, k=3), which has layered structure with an InO_2^{-1} layer of cubic bixbyte and a $4In_{1/4}Zn_{3/4}O^{1/4+}$ layer of the Würzite structure stack repeatedly along the c-axis, shows the best electrical conductive properties [14,15]. It is also known that the In-O layer has a coordination number of 6 while, depending on the circumstances, the In-Zn-O layer has a CN of 4 or 5. When Mg is doped in IZO, it is thought that Mg might replace the Zn that is located on the $4\text{In}_{1/4}\text{Zn}_{3/4}$ ${}_{4}\mathrm{O}^{1/4+}$ layers in the IZO (k=3) when the charge valence and ionic radius are considered. On the other hand, recently, Kim et al. reported that the transfer characteristics of thin film transistors (TFT) by using Mg incorporated IZO semiconductor channels [16]. They found that the turn-on-voltage of the TFT increased and the offcurrent decreased as the Mg content was increased. This was explained as being due to the reduction in the oxygen vacancy which resulted in decreased carrier concentration in the Mg doped IZO film. However, more systematic experiments on the band gap engineering have not been performed.

On the basis of the band gap modulation as mentioned above, this study focused on the effect of Mg doping in the In_2O_3 –ZnO (IZO) system to determine whether the band gap could also be adjusted in the same system. The thin films of the IZO (k=3) were deposited on glass substrates as a function of the Mg content. The lattice constant, optical transmittance, band gap energy and other electrical characteristics of the thin films were analyzed.

2. Experimental procedure

Targets of the $In_2O_3(Zn_{1-x}Mg_xO)_3$ for thin film deposition were prepared through the general solid state reaction process using high purity chemicals of In_2O_3 (Samsung Corning, Korea, 99.9%), ZnO (Aldrich, USA, 99.9%) and MgO (High Purity Chemicals, Japan, 99.9%). The amount of the dopant of MgO in the In_2O_3 ($Zn_{1-x}Mg_xO)_3$ was varied in the rage x=0–0.5 with an interval of 0.1. The weighed powders were wet mixed for 24 h in a plastic jar with zirconia balls and ethanol. After drying, the powder was formed into 6.5 cm diameter cakes by a sequential process of uniaxial pressing, followed by cold isostatic pressing (CIP). Subsequent CIP of the green compact was conducted at 100 MPa for 5 min. The cakes were sintered at 1300 °C for 4 h at a heating rate of 5 °C/min followed by furnace cooling.

The substrate of the soda–lime glass was cleaned in TCE (Trichloroethylene), acetone and ethyl alcohol in a sequence by an ultrasonic cleaner, then dried with nitrogen gas. Thin films of the $In_2O_3(Zn_{1-x}Mg_xO)_3$ were deposited on the glass substrates at 300 °C by using rf magnetron sputtering in pure Ar gas, whereas the oxygen partial pressure (Ar:O₂ ratio) of the deposition ambient was changed for the case of the x=0.2 samples. Prior to the deposition, the chamber was evacuated to a background pressure of 1.0×10^{-6} Torr initially, and both the working

pressure and the rf power were fixed to 10 mTorr and 50 W, respectively. A low incident beam X-ray diffraction with nickel-filtered Cu-K α radiation (Phillips, X'Pert PROMRD, Netherlands) was used for the phase identification of the thin films. Electrical characteristics of the thin films were analyzed using a Hall effect measurement system (Ecopia, HMS-3000) in a constant magnetic field of 1 T at room temperature. The optical characteristics were determined using a UV/VIS/NIR spectrophotometer (Philips, CARY 5G, Australia).

3. Results and discussion

The X-ray diffraction patterns of the thin films deposited at 300 °C as a function of the Mg content in $In_2O_3(Zn_{1-x}Mg_xO)_3$ (x=0–0.5) are presented in Fig. 1. The result of the X-ray diffraction showed that only one diffraction peak corresponded to the (0015) plane of $In_2O_3(ZnO)_3$ (k=3) appeared around 2θ =31° which implies that the films are preferentially oriented along the [001] direction. The c-axis orientation of the $In_2O_3(ZnO)_k$ thin films has been reported elsewhere [5,6]. The peak position of the (0015) plane moved to a higher diffraction angle with an increase of the Mg content, which signifies that the lattice constant of the c-axis of $In_2O_3(Zn_{1-x}Mg_xO)_3$ decreased. On the other hand, (0015) diffraction intensity decreased as the content of Mg increased, then disappeared finally at x=0.5 and an amorphous like broad peak around $2\theta \approx 40$ ° was observed.

It is generally accepted that the crystallization and/or crystallinity is retarded as the number of components (species) increases in a system [17], since increasing the number of components results in an increase of entropy. This phenomena has been observed in the thin films of indium zinc oxide (IZO), indium zinc gallium oxide (IZGO), and indium zinc antimony oxide (IZAO). In this case, a higher thermal activation energy is necessary for crystallization.

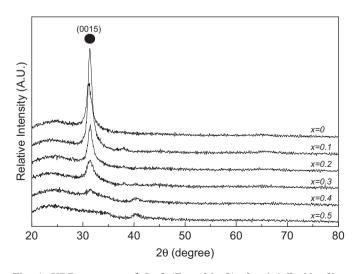
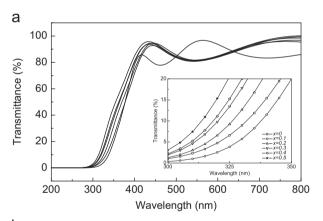


Fig. 1. XRD patterns of $In_2O_3(Zn_{1-x}Mg_xO)_3$ [x=0-0.5] thin films deposited in pure Ar on the glass substrate at 300 °C.

Fig. 2 shows the (a) optical transmittance spectra of the thin films in the visible lightwave range, and the (b) lattice constant vs. band gap relationship as a function of the Mg content. The optical transparency of the films revealed almost the same with fairly good transparency values above 80%, and the absorption edge moved to shorter wavelengths as the Mg content increased. On the basis of the absorption edge, the optical band gap (Eg) of the thin films was calculated from the $(ahv)^2$ vs. hv relationship where h is Planck's constant and v is the frequency. The band gap showed an increasing tendency from 3.6 to 3.8 eV as the Mg content increased. The increase in the band gap has been also reported in the Mg-doped ZnO systems [5–8]. Since the layer-structured $In_2O_3(Zn_{1-x}Mg_xO)_3$ is composed of In_2O_3 and ZnO layers, the result is indicative of the fact that the Mg dopant incorporates in the ZnO layers and that the band gap had increased. The evaluated lattice constant for pure In₂O₃(ZnO)₃ and x = 0.4 was 42.83 Å and 42.46 Å, respectively. This is believed to be caused by the smaller ionic radius of Mg^{2+} (0.57 Å) than that of Zn^{2+} (0.60 Å).

The electrical characteristics analyzed by the Hall measurement are presented in Fig. 3. The carrier concentration was quite high, reaching 10^{22} cm⁻³ for the cases of pure IZO, x=0.1 and x=0.2 while further addition of Mg resulted in the decrease of carrier concentration.



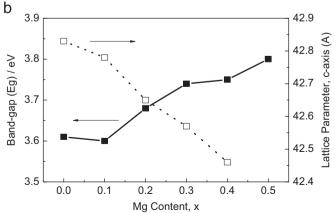


Fig. 2. (a) Transmittance curves and (b) lattice parameter and band-gap variation of $In_2O_3(Zn_{1-x}Mg_xO)_3$ [x=0–0.5] thin films deposited in pure Ar on the glass substrate at 300 °C.

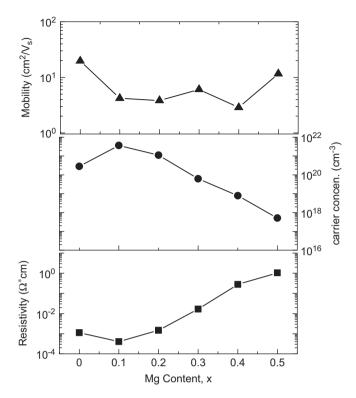


Fig. 3. Electrical properties of $In_2O_3(Zn_{1-x}Mg_xO)_3$ [x=0-0.5] thin films deposited in pure Ar on the glass substrate at 300 °C.

The resistivity with the Mg content increased accordingly. The mobility stayed within the range $3-20 \text{ cm}^2/\text{V}$ s.

On the other hand, another factor that can affect band gap energy could be carrier concentration. In the case of the degenerated n-type semiconductive materials, the Fermi level lies in the conduction band. Therefore, when carrier concentration increases, according to the Burstein–Moss effect [12,13], band gap (ΔEg) increases in proportion to the exponent of 2/3 of the carrier concentration as shown in

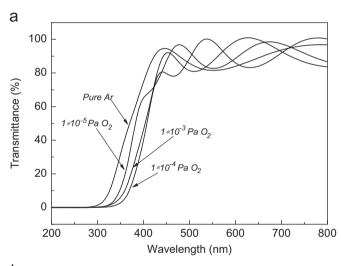
$$\Delta E g = (h^2 / 2m_e)(3n/8\pi)^{2/3} \tag{1}$$

where h is Plank's constant $(4.13 \times 10^{-15} \text{ eV s})$; m_e is the electron mass $(9.11 \times 10^{-31} \text{ kg})$ and n is the carrier concentration.

Even though the carrier concentration decreased with the increase of Mg content as shown in Fig. 3, the band gap also increased. It seemed that the effect of the carrier concentration has been compensated by the effect of the lattice constant.

In the case of most semiconducting and conducting oxide films, oxygen partial pressure of deposition ambient greatly affects carrier concentration, which in turn will influence band gap energy. In this study, therefore, the effect of oxygen ambient on band gap energy was examined when the content of Mg was x=0.2 (In₂O₃(Zn_{0.8}Mg_{0.2}O)₃). The temperature of the glass substrates, working pressure and rf power were fixed to 300 °C, 10 mTorr and 50 W, respectively, while the respective Ar:O₂ ratios were varied from pure Ar, 1000:1, 100:1 and 10:1.

Fig. 4 shows the (a) optical transmittance spectra of the thin films and (b) the band gap vs. the carrier concentration relationship. The band gap was obtained from the absorption edge of the transmittance spectra (a) and the carrier concentration of the thin films was measured from the Hall effect measurement system. No differences in the lattice constant of the thin films as a function of the oxygen partial pressure were observed. However, the oxygen partial pressure affected the wavelength of the absorption edge which shifted to the shorter wavelengths as the oxygen partial pressure decreased. This blueshift has a close relationship with the carrier concentration as shown in Fig. 4(b) as the band gap is proportional to the carrier concentration. IZO is an n-type conductive material in which many of the intrinsic defects of oxygen vacancies exist. When the oxygen partial pressure increases during thin film deposition, the number of oxygen vacancies will decrease, which in turn will reduce the carrier concentration. The relationship between the band gap vs. the carrier concentration presented in Fig. 4(b) is attributed to the Burstein-Moss effect. The oxygen partial pressure



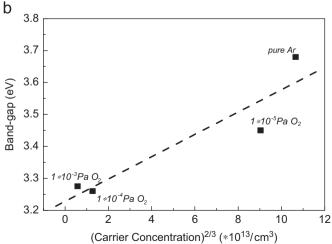


Fig. 4. (a) Transmittance curve and (b) hv vs. carrier concentration of $In_2O_3(Zn_{0.8}Mg_{0.2}O)_3$ thin films deposited in various oxygen partial pressures on the glass substrate at 300 °C.

dependent band gap shift due to the Burstein–Moss effect has also been reported in the Ga-doped ZnO and MgIn₂O₄ systems [18–21].

Fig. 5 shows the electrical characteristics of the $In_2O_3(Zn_{0.8}Mg_{0.2}O)_3$ thin films analyzed by the Hall measurement. The carrier concentration decreased and the resistivity increased as the oxygen partial pressure increased while the mobility stayed in the range between 1 and $10 \text{ cm}^2/\text{V}$ s.

4. Conclusion

The effect Mg content in $In_2O_3(Zn_{1-x}Mg_xO)_3$ thin films grown by the rf magnetron sputtering method was examined. The crystallization of the thin films retarded as the Mg content increased, whereas all the crystallized thin films showed a preferred *c*-axis orientation. The lattice constant was found to decrease with the increases of Mg content. Regardless of the Mg content, the optical transmittance of the thin films was fairly high above 80%, and sharp absorption edges were observed. The band gap energy of the IZO increased with the increasing Mg content, and the band gap was inversely proportional to the lattice constant.

Concerning the effect of the oxygen partial pressure in the $\rm In_2O_3(Zn_{0.8}Mg_{0.2}O)_3$ thin films, the band gap energy increased as the oxygen partial pressure decreased due to the increased carrier concentration which was explained by the Burstein–Moss effect.

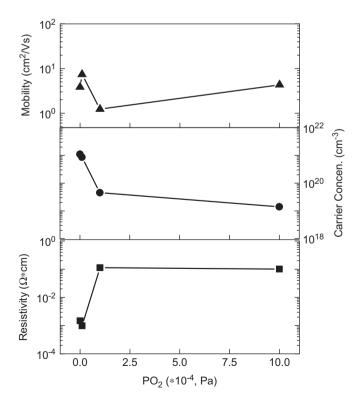


Fig. 5. Electrical properties of $In_2O_3(Zn_{0.8}Mg_{0.2}O)_3$ thin films deposited in various oxygen partial pressures on the glass substrate at 300 $^{\circ}C.$

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